SONY

[Product Information]

Ver.1.0

IMX426LQJ

Diagonal 9.2 mm (Type 1 / 1.7) CMOS solid-state Image Sensor with Square Pixel for Color Cameras

Description

The IMX426LQJ is a diagonal 9.2 mm (Type 1 / 1.7) CMOS active pixel type solid-state image sensor with a square pixel array and 0.51 M effective pixels. This chip features a global shutter with variable charge-integration time. This chip operates with analog 3.3 V, digital 1.2 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and low PLS characteristics are achieved.

(Applications: FA cameras, ITS cameras)

Features

- ◆ CMOS active pixel type dots
- ◆ Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Global shutter function
- ♦ Input frequency 37.125 MHz / 74.25 MHz / 54 MHz
- ◆ Number of recommended recording pixels: 812 (H) x 620 (V) approx. 0.50 M pixels

Readout mode

All-pixel scan mode

ROI mode

Vertical / Horizontal - Normal / Inverted readout mode

◆ Readout rate

Maximum frame rate in

All-pixel scan mode: 8 bit 1594.7 frame/s, 10 bit: 1449.7 frame/s, 12 bit: 941.4 frame/s

- ◆ Variable-speed shutter function (resolution 1 H units)
- ◆8-bit / 10-bit / 12-bit A/D converter
- ♦ CDS / PGA function

0 dB to 24 dB: Analog Gain (0.1 dB step)

24.1 dB to 48 dB: Analog Gain: 24 dB + Digital Gain: 0.1 dB to 24 dB (0.1 dB step)

◆ I/O interface

SLVS (2 ch / 4 ch / 8 ch switching) output (594 / 297 Mbps per 1 ch)

SLVS - EC (1 Lane / 2 Lane / 4 Lane / 8 Lane) output (2.376 / 1.188 Gbps per 1 Lane)

- ◆ Recommended lens F number: 2.8 or more (Close side)
- ◆ Recommended exit pupil distance: -100 mm to -∞

Pregius

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^{*} Pregius is a trademark of Sony Corporation. The Pregius is global shutter pixel technology for active pixel-type CMOS image sensors that use Sony's low-noise CCD structure, and realizes high picture quality.

Device Structure

◆ CMOS image sensor

♦ Image size Diagonal 9.2 mm (Type 1 / 1.7) Approx. 0.51 M pixels All-pixel

◆ Total number of pixels816 (H) × 656 (V)Approx. 0.54 M pixels◆ Number of effective pixels816 (H) × 624 (V)Approx. 0.51 M pixels◆ Number of active pixels816 (H) × 624 (V)Approx. 0.51 M pixels

◆ Number of recommended recording pixels 812 (H) x 620 (V) Approx. 0.50 M pixels All-pixel

lacktriangle Unit cell size 9.0 μ m (H) \times 9.0 μ m (V)

♦ Optical black Horizontal (H) direction: Front 0 pixel, rear 0 pixel

Vertical (V) direction: Front 32 pixels, rear 0 pixel

◆ Package 226 pin LGA

Image Sensor Characteristics (Preliminary)

(Tj = 60 °C)

ltem		Value	Remarks	
Sensitivity (F5.6)	Тур.	4910 mV	1/30 s accumulation	
Saturation signal	Min.	1001 mV		

Basic Drive Mode

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
All pixel	812 (H) × 620 (V) approx. 0.50 M pixels	752.8	SLVS 8 ch	8
		1594.7	SLVS – EC 8 Lane	
		622.7	SLVS 8 ch	10
		1449.7	SLVS – EC 8 Lane	
		542.7	SLVS 8 ch	12
		941.4	SLVS – EC 8 Lane	